

Notice of References Cited	Application/Control No. 10/786,307	Applicant(s)/Patent Under Reexamination KIM ET AL.	
	Examiner Biju Chandran	Art Unit 2835	Page 1 of 1

U.S. PATENT DOCUMENTS

*		Document Number Country Code-Number-Kind Code	Date MM-YYYY	Name	Classification
*	A	US-6,328,097 B1	12-2001	Bookhardt et al.	165/104.33
	B	US-			
	C	US-			
	D	US-			
	E	US-			
	F	US-			
	G	US-			
	H	US-			
	I	US-			
	J	US-			
	K	US-			
	L	US-			
	M	US-			

FOREIGN PATENT DOCUMENTS

*		Document Number Country Code-Number-Kind Code	Date MM-YYYY	Country	Name	Classification
	N					
	O					
	P					
	Q					
	R					
	S					
	T					

NON-PATENT DOCUMENTS

*		Include as applicable: Author, Title Date, Publisher, Edition or Volume, Pertinent Pages)
	U	David A. Reay, Heat Pipe, in AccessScience@McGraw-Hill, http://www.accessscience.com , DOI 10.1036/1097-8542.757297, May 13, 2002
	V	Charles A. Harper, Cooling with Heat Pipes, Electronic packaging & Interconnection Handbook, Pages 2.79-2.80, Mc-Graw Hill, 1997
	W	
	X	

*A copy of this reference is not being furnished with this Office action. (See MPEP § 707.05(a).)
Dates in MM-YYYY format are publication dates. Classifications may be US or foreign.